# Application Data Sheet APPLICATION INFORMATION

Secrecy Order in Parent Appl.?:: No

Application Number::	
Filing Date::	
Application Type::	Regular
Subject Matter::	Utility
Suggested classification::	
Suggested Group Art Unit::	
CD-ROM or CD-R?::	None
Number of CD Disks:	
Number of Copies of CDs::	
Sequence Submission?::	
Computer Readable From (CRF)	?:: No
Number of Copies of CRF::	
Title::	SEMICONDUCTOR DEVICE AND
	MANUFACTURING METHOD THEREOF
Attorney Docket Number::	403031
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	
Total Drawing Sheets::	24
Small Entity?::	No
Latin Name::	
Variety denomination name::	
Petition Included?::	No
Petition Type::	
Licensed US Govt. Agency::	
Contract or Grant Numbers::	

# **APPLICANT INFORMATION**

Applicant Authority Type:: Inventor

Primary Citizenship Country:: JP

Status:: Full Capacity

Given Name:: Shunichi

Middle Name::

Family Name:: ABE

Name Suffix::

City of Residence:: Hyogo

State or Prov. of Residence::

Country of Residence:: JP

Street of mailing address:: c/o Mitsubishi Denki Kabushiki Kaisha,

2-3, Marunouchi 2-chome, Chiyoda-ku

City of mailing address:: Tokyo

State or Province of mailing address::

Country of mailing address:: JP

Postal or Zip Code of mailing address:: 100-8310

Applicant Authority Type:: Inventor

Primary Citizenship Country:: JP

Status:: Full Capacity

Given Name:: Tetsuya

Middle Name::

Family Name:: UEBAYASHI

Name Suffix::

City of Residence:: Hyogo

State or Prov. of Residence::

Country of Residence:: JP

Street of mailing address:: c/o Mitsubishi Denki Kabushiki Kaisha,

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State or Province of mailing address::

Country of mailing address:: JP

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Postal or Zip Code of mailing address:: 100-8310

Inventor Applicant Authority Type::

JP Primary Citizenship Country::

**Full Capacity** Status::

Naoki Given Name::

Middle Name::

Name Suffix::

IZUMI Family Name::

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State or Prov. of Residence::

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State or Province of mailing address::

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Inventor Applicant Authority Type::

JP Primary Citizenship Country::

**Full Capacity** Status::

Akira Given Name::

Middle Name::

YAMAZAKI Family Name::

Name Suffix:: Hyogo City of Residence::

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State or Province of mailing address::

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Country of mailing address::

Postal or Zip Code of mailing address:: 100-8310

# **CORRESPONDENCE INFORMATION**

Correspondence Customer Number:: 23548

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E-mail Address:: dcmail2@leydig.com

# REPRESENTATIVE INFORMATION

Representative Customer Number:: 23548

Representative Designation:: Registration Number:: Representative Name::

JP

# **DOMESTIC PRIORITY INFORMATION**

Application:: Continuity Type:: Parent Application:: Parent Filing Date::

This Application Division of 10/892,539 6/28/2001

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# FOREIGN APPLICATION INFORMATION

Country::

Application Number:: Filing Date::

**Priority Claimed** 

JP

2001-032362

2/8/2001

Yes

# **ASSIGNEE INFORMATION**

Assignee name::

Renesas Technology Corp.

Street of mailing address:: 4-1, Marunouchi 2-chome,

Chiyoda-ku

City of mailing address::

Tokyo

State or Province of mailing address::

Country of mailing

address::

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Postal or Zip Code of

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